

ABSTRACT OF THE DISCLOSURE

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a1* 5 ~~A conduction means having conduction path for injecting~~
molten molding material within a mold space is fitted to one
of a pair of mold bodies which form the disc-shaped mold space.
A first heat suppressing means for suppressing heat within the
conduction path from being transmitted to the one of the mold
bodies is disposed between the conduction means and the one
of the mold bodies. Further, a second heat suppressing means
is disposed at a position opposing to the first heat suppressing
10 means at the time of mold-clamping the pair of the mold bodies.

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